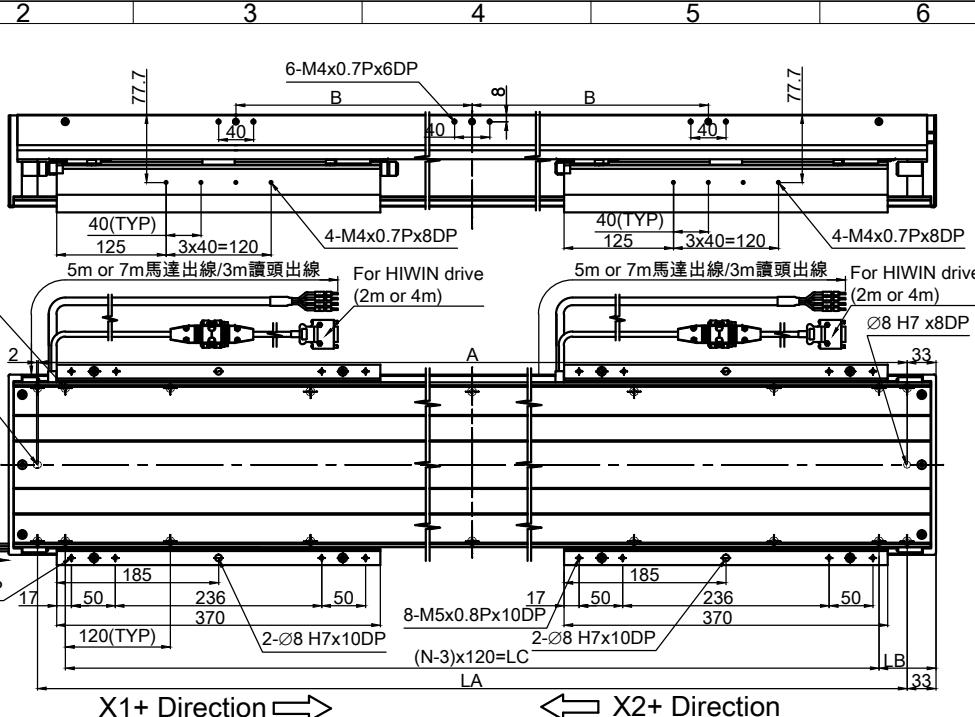
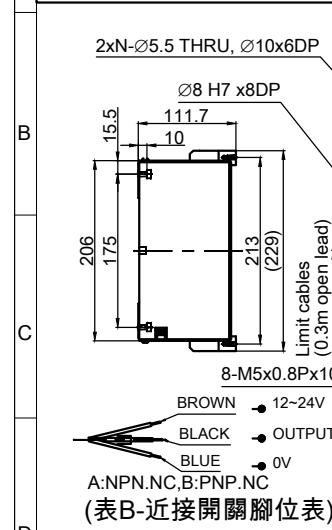


1	2	3	4	5	6	7	8	9
Customer sign								



HIWIN CONFIDENTIAL
機密文件未經許可，嚴禁複製
PF Number : \

(表A-需求規格表)

挑選精度(V)	讀頭編碼	解析度		重現精度		絕對精度(註4)				
		K	Digital 0.1 μm optical	± 1 μm	± 2 μm	E	Digital 1 μm optical	± 3 μm	± 6 μm	
挑選尺寸(V)	行程	尺寸		機台重量(kg)						
		LT	N	LA	LB	LC	A	B		
1100	1140	2030	19	1964	55	1920	1963	600	77.5	
1150	1190	2080	19	2014	80	1920	2013	600	79.1	
1200	1240	2130	19	2064	105	1920	2063	600	80.7	
1250	1290	2180	19	2114	130	1920	2113	840	82.2	
1300	1340	2230	19	2164	155	1920	2163	840	83.8	
1400	1440	2330	21	2264	85	2160	2263	840	86.9	
1500	1540	2430	21	2364	135	2160	2363	840	90.1	
1600	1640	2530	23	2464	65	2400	2463	840	93.2	
1700	1740	2630	23	2564	115	2400	2563	840	96.3	
1800	1840	2730	25	2664	45	2640	2663	1080	99.4	
1900	1940	2830	25	2764	95	2640	2763	1080	102.6	
2000	2040	2930	25	2864	145	2640	2863	1080	105.7	
HIWIN MIKROSYSTEM CORP.						TYPE	SSA-20C200 (Stroke1100~2000)			
ROUGH %			FIT %	GRD	SCALE		CUSTOMER			
8.0a		3.2a	VV		0.8a		DATE Apr.08.20			
∇		$\nabla\nabla$		$\nabla\nabla$		DWN 饒佑隆				
TOLERANCE mm			1:X		MATERIAL		CHK 蔡政翰			
UP TO 6	30 120	120 300	300 600	600 1200	1200 2400	OVER 2400	PART NO \	APPD 顏祐臨	NAME DWG NO SHEET	
± 0.1	± 0.2	± 0.3	± 0.4	± 0.5	± 0.8	± 1.0	± 1.5	APPROVAL \	A1 1-1	

(表D-讀頭腳位表)

ITEM	DATE	MODIFIED	DESCRIPTION		ECN NO.	CHK	APPD